

### **KSD1222**

# Power Amplifier Applications High DC Current Gain

- Low Collector-Emitter Saturation Voltage
- Built in a Damper Diode at E-C
- Darlington TR
- Complement to KSB907



### **NPN Epitaxial Silicon Transistor**

### **Absolute Maximum Ratings** T<sub>C</sub>=25°C unless otherwise noted

| Symbol           | Parameter                                    | Value      | Units |
|------------------|--|------------|-------|
| V <sub>CBO</sub> | Collector-Base Voltage                       | 60         | V     |
| V <sub>CEO</sub> | Collector-Emitter Voltage                    | 40         | V     |
| V <sub>EBO</sub> | Emitter-Base Voltage                         | 5          | V     |
| I <sub>C</sub>   | Collector Current                            | 3          | Α     |
| I <sub>B</sub>   | Base Current                                 | 0.3        | Α     |
| P <sub>C</sub>   | Collector Dissipation (T <sub>C</sub> =25°C) | 15         | W     |
|                  | Collector Dissipation (T <sub>a</sub> =25°C) | 1          | W     |
| TJ               | Junction Temperature                         | 150        | °C    |
| T <sub>STG</sub> | Storage Temperature                          | - 55 ~ 150 | °C    |

### Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

| Symbol                               | Parameter                            | Test Condition   | Min.         | Тур. | Max. | Units |
|--------------------------------------|--------------------------------------|--|--------------|------|------|-------|
| BV <sub>CEO</sub>                    | Collector-Emitter Breakdown Voltage  | $I_C = 25 \text{mA}, I_B = 0$                          | 40           |      |      | V     |
| I <sub>CBO</sub>                     | Collector Cut-off Current            | $V_{CB} = 60V, I_{E} = 0$                              |              |      | 20   | μΑ    |
| I <sub>EBO</sub>                     | Emitter Cut-off Current              | $V_{EB} = 5V, I_{C} = 0$                               |              |      | 2.5  | mA    |
| h <sub>FE1</sub><br>h <sub>FE2</sub> | DC Current Gain                      | $V_{CE} = 2V, I_{C} = 1A$<br>$V_{CE} = 2V, I_{C} = 3A$ | 2000<br>1000 |      |      |       |
| V <sub>CE</sub> (sat)                | Collector-Emitter Saturation Voltage | $I_C = 2A$ , $I_B = 4mA$                               |              |      | 1.5  | V     |
| V <sub>BE</sub> (sat)                | Base-Emitter Saturation Voltage      | $I_C = 2A, I_B = 4mA$                                  |              |      | 2    | V     |
| t <sub>ON</sub>                      | Turn On Time                         | $V_{CC} = 30V, I_{C} = 3A$                             |              | 0.1  |      | μs    |
| t <sub>STG</sub>                     | Storage Time                         | $I_{B1} = -I_{B2} = 6mA$                               |              | 1    |      | μs    |
| t <sub>F</sub>                       | Fall Time                            | $R_L = 10\Omega$                                       |              | 0.2  |      | μs    |

 $V_{CE} = 2V$ 

## **Typical Characteristics**

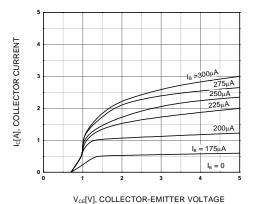
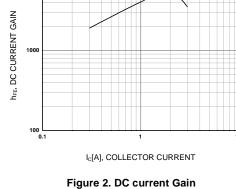


Figure 1. Static Characteristic



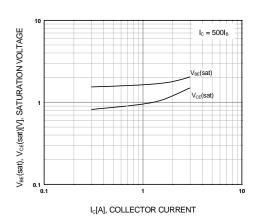


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

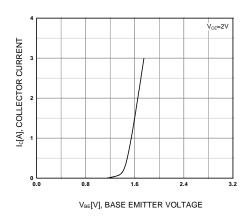


Figure 4. Base-Emitter On Voltage

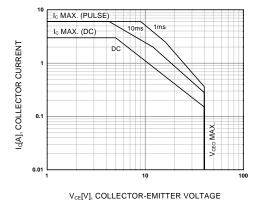


Figure 5. Safe Operating Area

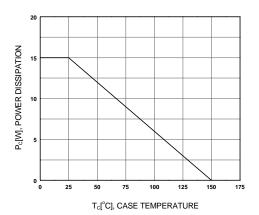
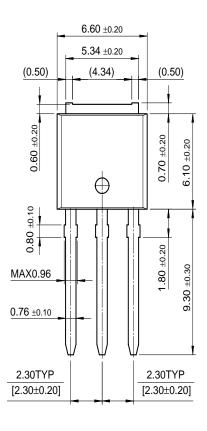


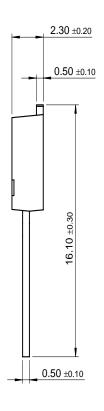
Figure 6. Power Derating

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## **Package Demensions**

## I-PAK







Dimensions in Millimeters

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| EcoSPARK™                        | ISOPLANAR™          | QT Optoelectronics™      | UltraFET <sup>®</sup> |
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| EnSigna™                         | MicroFET™           | SLIENT SWITCHER®         |                       |
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Rev. H2

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